

# SPECIFICATION

23

Device Name : POWER MOSFET

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Type Name : 2SK2872-01MR

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Spec. No. :

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Fuji Electric Co., Ltd.  
Matsumoto Factory

	DATE	NAME	APPROVED	Fuji Electric Co., Ltd.	
DRAWN				DWG. NO.	Y/12
CHECKED					

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- 1.Scope This specifies Fuji Power MOSFET 2SK2872-01MR
- 2.Construction N-Channel enhancement mode power MOSFET
- 3.Applications for Switching
- 4.Outview TO-220F Outview See to 5/12 page

**5.Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)**

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	$V_{DS}$	450	V	
Continuous Drain Current	$I_D$	$\pm 8$	A	
Pulsed Drain Current	$I_{DP}$	$\pm 32$	A	
Gate-Source Voltage	$V_{GS}$	$\pm 35$	V	
Repetitive or non-repetitive	$I_{AV}$	8	A	$T_{ch} \leq 150^\circ\text{C}$
Maximum Avalanche Energy	$E_{AV}$	164.1	mJ	*1
Maximum Power Dissipation	$P_D$	30	W	
Operating and Storage	$T_{ch}$	150	$^\circ\text{C}$	
Temperature range	$T_{stg}$	-55 to +150	$^\circ\text{C}$	

\*1 L=4.70mH, Vcc=45V

**6.Electrical Characteristics at Tc=25°C (unless otherwise specified)**

**Static Ratings**

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	450	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=450\text{V}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$	-	10	500	$\mu\text{A}$
		$T_{ch}=125^\circ\text{C}$	-	0.2	1.0	mA
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 35\text{V}$ $V_{DS}=0\text{V}$	-	10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$I_D=4\text{A}$ $V_{GS}=10\text{V}$	-	1.0	1.2	$\Omega$

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### Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	$g_{fs}$	$I_D=4A$ $V_{DS}=25V$	2	4	-	S
Input Capacitance	$C_{iss}$	$V_{DS}=25V$	-	540	810	pF
Output Capacitance	$C_{oss}$	$V_{GS}=0V$	-	100	150	
Reverse Transfer Capacitance	$C_{rss}$	$f=1MHz$	-	45	70	
Turn-On Time	$t_{d(on)}$	$V_{cc}=300V$	-	13	20	ns
	$t_r$	$V_{GS}=10V$	-	45	70	
Turn-Off Time	$t_{d(off)}$	$I_D=8A$	-	40	60	
	$t_f$	$R_{GS}=10\Omega$	-	25	40	

### Reverse Diode

Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	$I_{AV}$	$L=4.70mH$ $T_{ch}=25^\circ C$ See Fig.1 and Fig.2	8	-	-	A
Diode Forward On-Voltage	$V_{SD}$	$I_F=2 \times I_{DR}$ $V_{GS}=0V$ $T_{ch}=25^\circ C$	-	1.1	1.65	V
Reverse Recovery Time	$t_{rr}$	$I_F=I_{DR}$	-	450	-	ns
Reverse Recovery Charge	$Q_{rr}$	$-di/dt=100A/\mu s$ $T_{ch}=25^\circ C$	-	3.7	-	$\mu C$

### 7. Thermal Resistance

Description	Symbol	min.	typ.	max.	Unit
Channel to Case	$R_{th(ch-c)}$			4.17	$^\circ C/W$
Channel to Ambient	$R_{th(ch-a)}$			62.5	$^\circ C/W$

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Fig.1 Test circuit

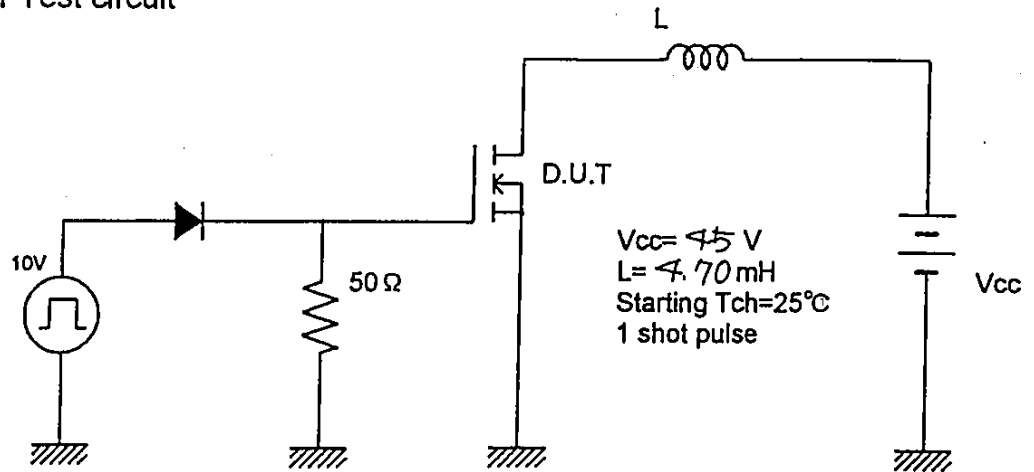
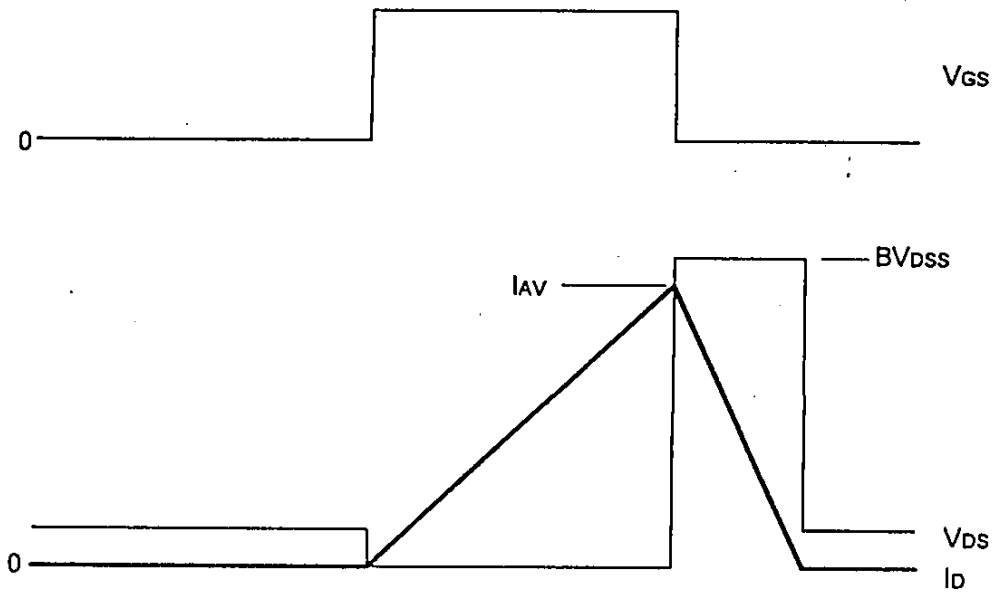
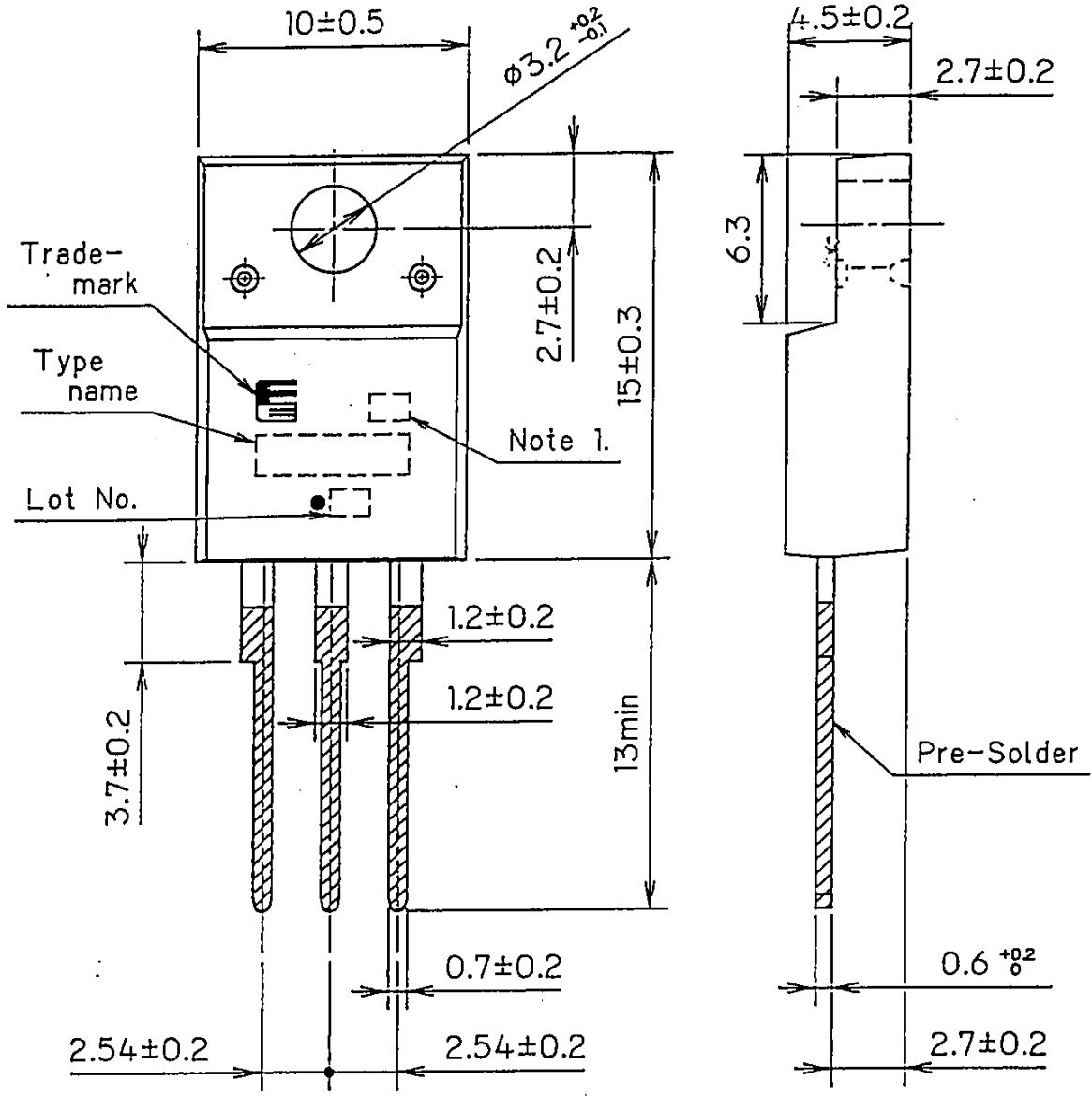


Fig.2 Operating waveforms

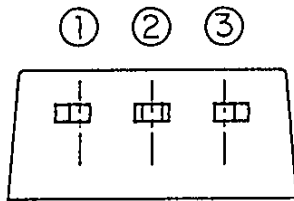


# FUJI POWER MOS FET

TYPE : \_\_\_\_\_



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## CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

Note 1. Guaranteed mark of avalanche ruggedness.

DIMENSIONS ARE IN MILLIMETERS.

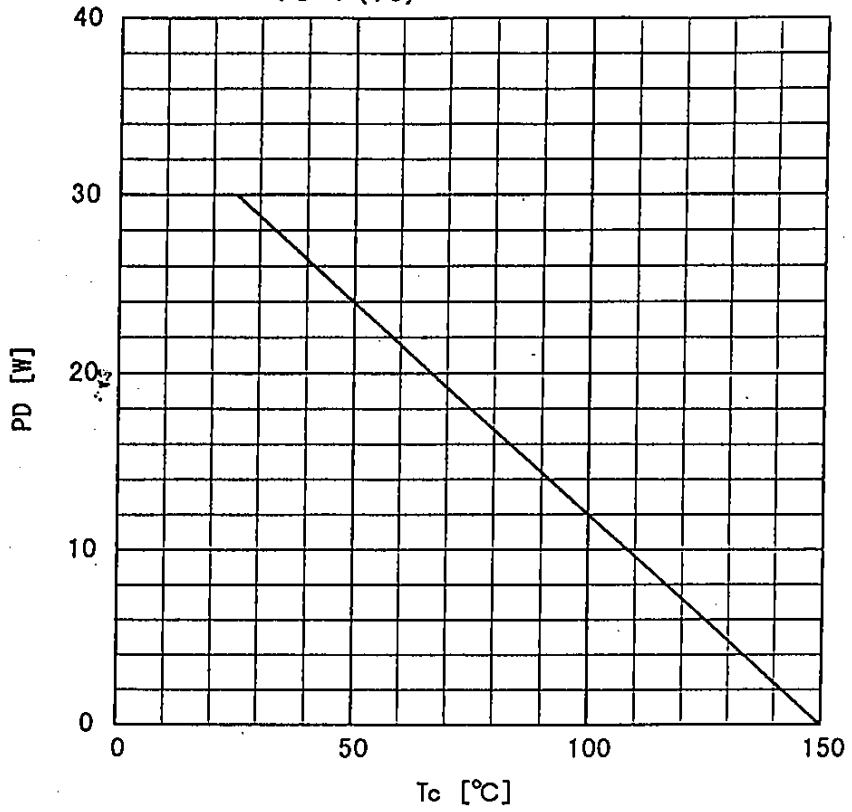
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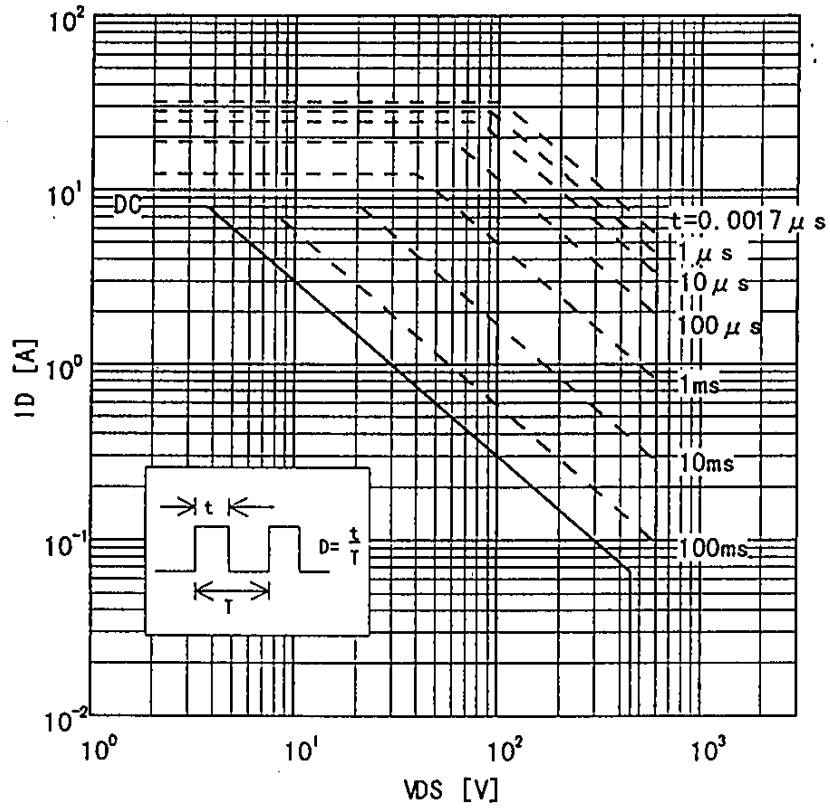
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Power Dissipation  
 $PD=f(T_c)$

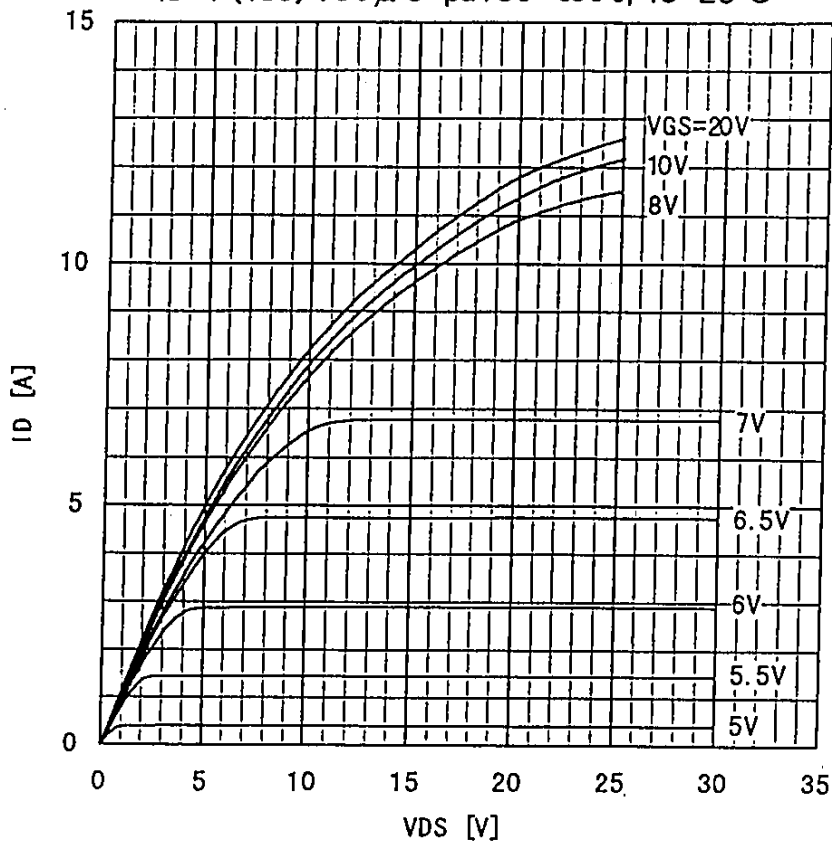


Safe operating area  
 $ID=f(V_{DS}) : D=0.01, T_c=25^\circ C$

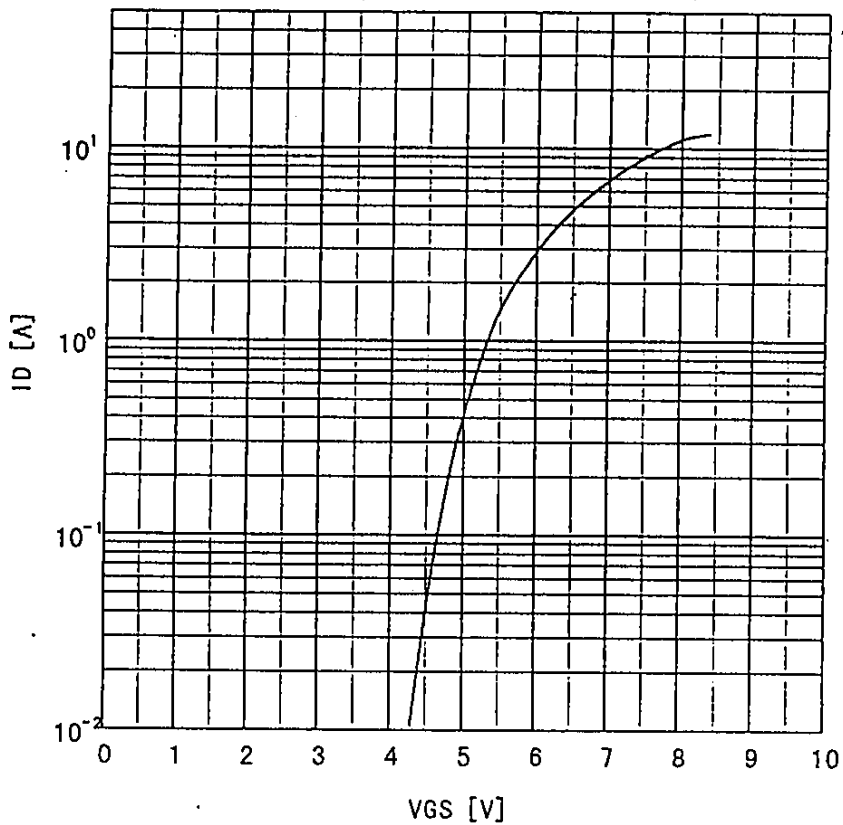


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Typical output characteristics  
 $I_D = f(V_{DS}) : 80 \mu s$  pulse test,  $T_c = 25^\circ C$

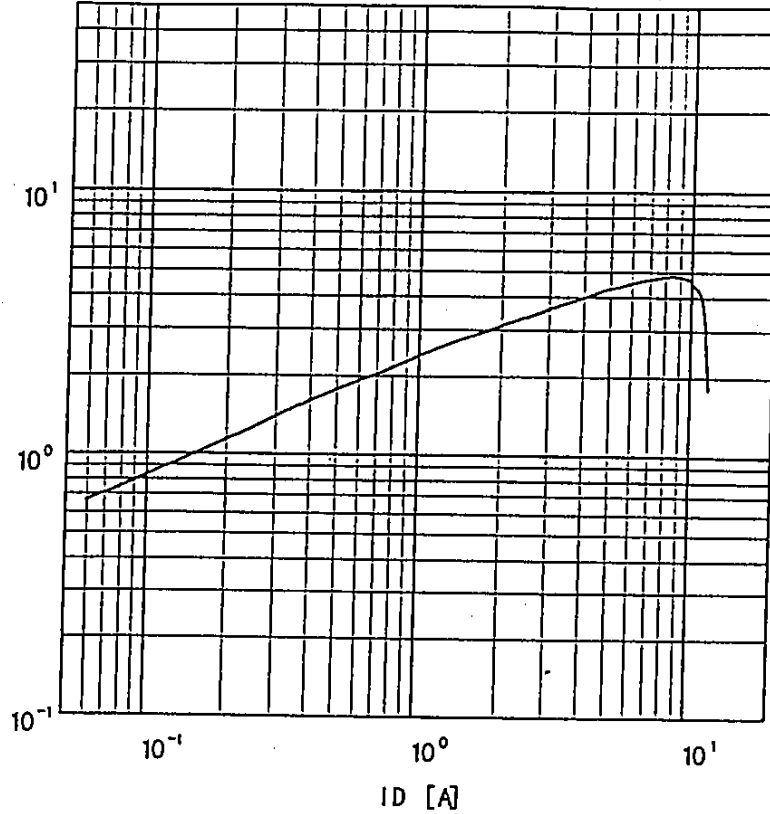


Typical transfer characteristic  
 $I_D = f(V_{GS}) : 80 \mu s$  pulse test,  $V_{DS} = 25V$ ,  $T_{ch} = 25^\circ C$

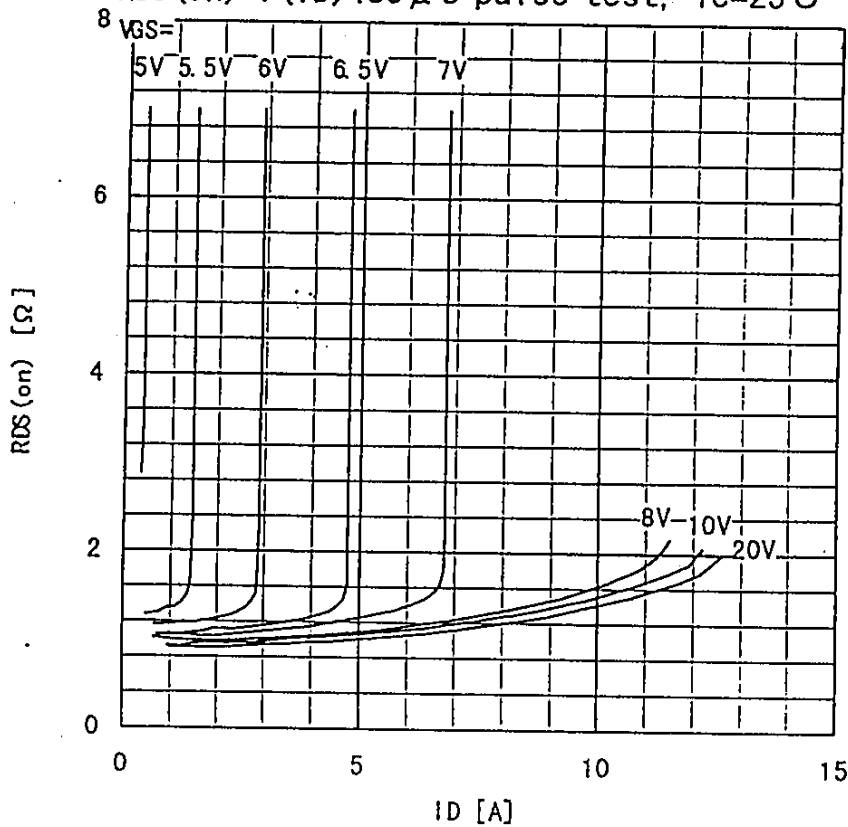


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Typical forward transconductance  
 $g_{fs}=f(I_D)$  : 80  $\mu$ s pulse test,  $V_{DS}=25V$ ,  $T_{ch}=25^\circ C$



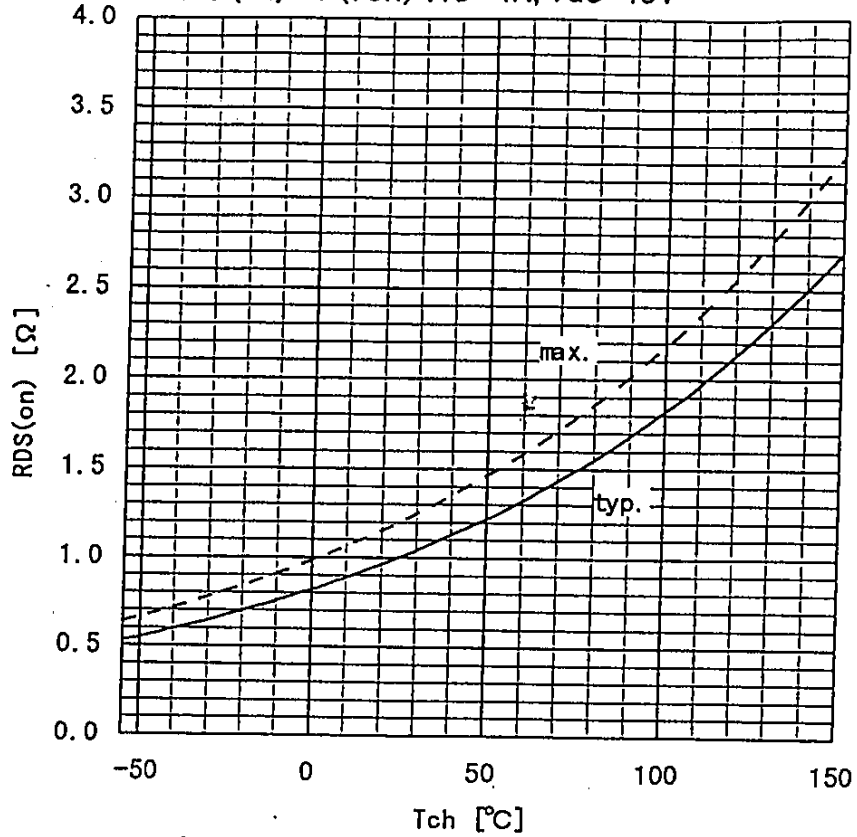
Typical drain-source on-state resistance  
 $R_{DS(on)}=f(I_D)$  : 80  $\mu$ s pulse test,  $T_c=25^\circ C$



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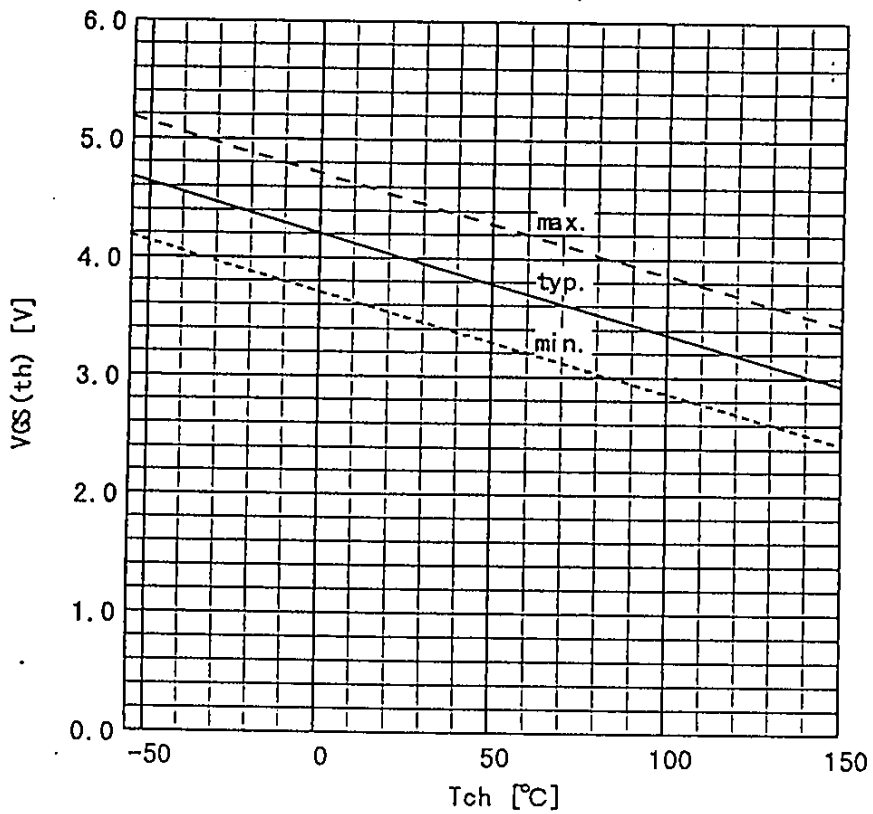
Drain-source on-state resistance

$R_{DS(on)} = f(T_{ch}) : I_D = 4A, V_{GS} = 10V$



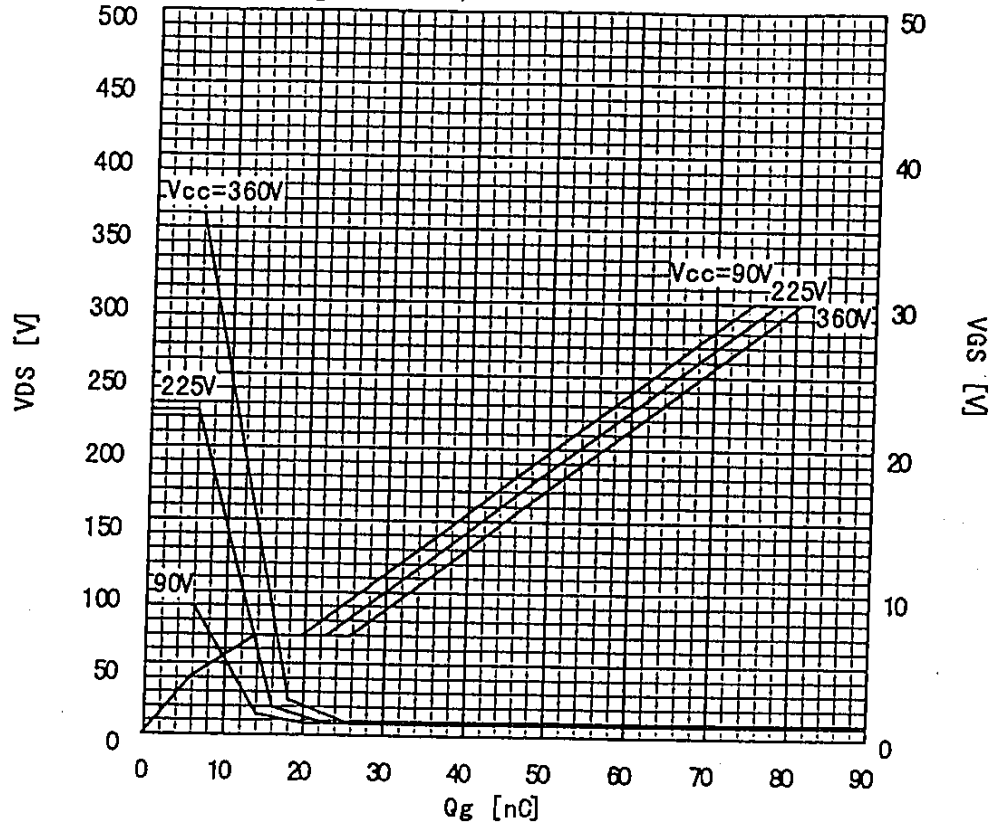
Gate threshold voltage

$V_{GS(th)} = f(T_{ch}) : I_D = 1mA, V_{DS} = V_{GS}$

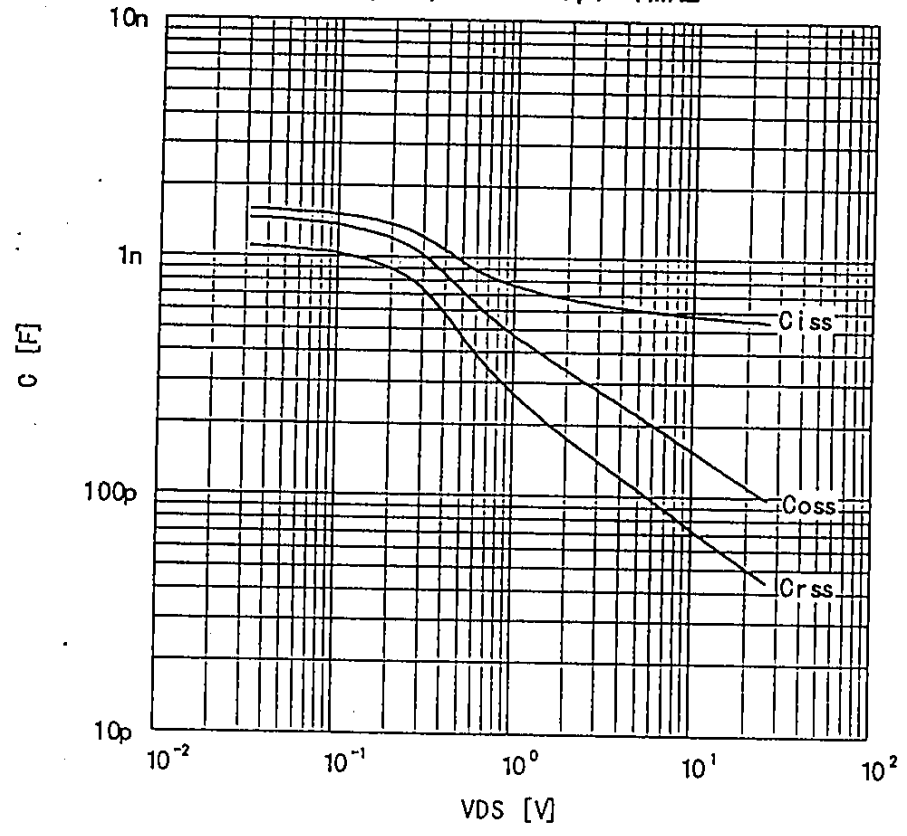


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Typical gate charge characteristic  
 $V_{GS} = f(Q_g) : I_D = 8A, T_c = 25^\circ C$

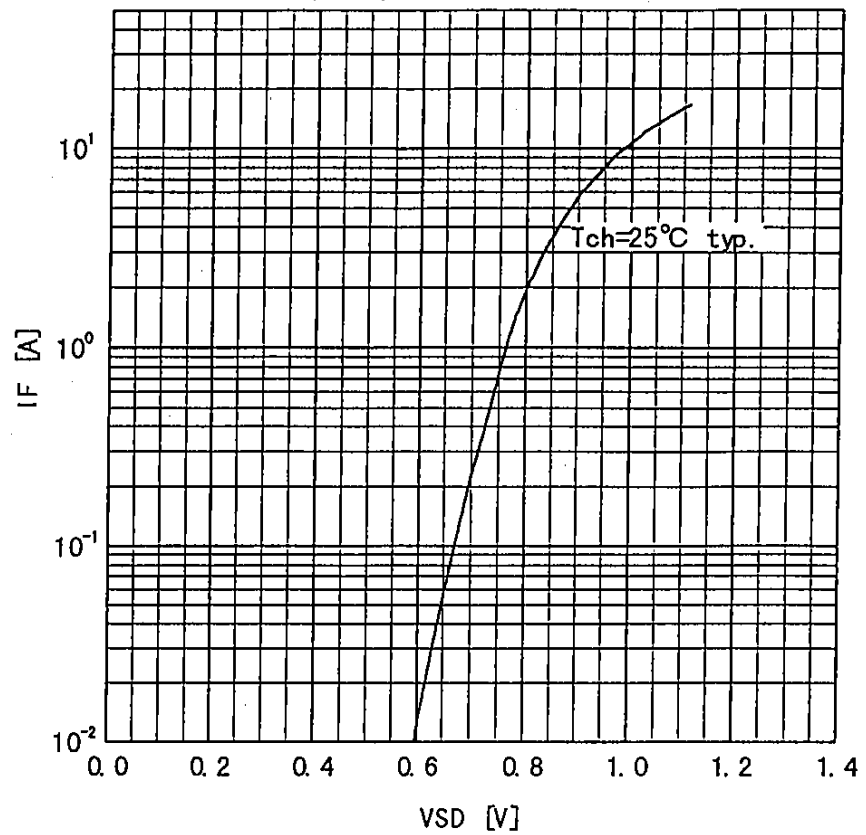


Typical capacitances  
 $C = f(V_{DS}) : V_{GS} = 0V, f = 1MHz$

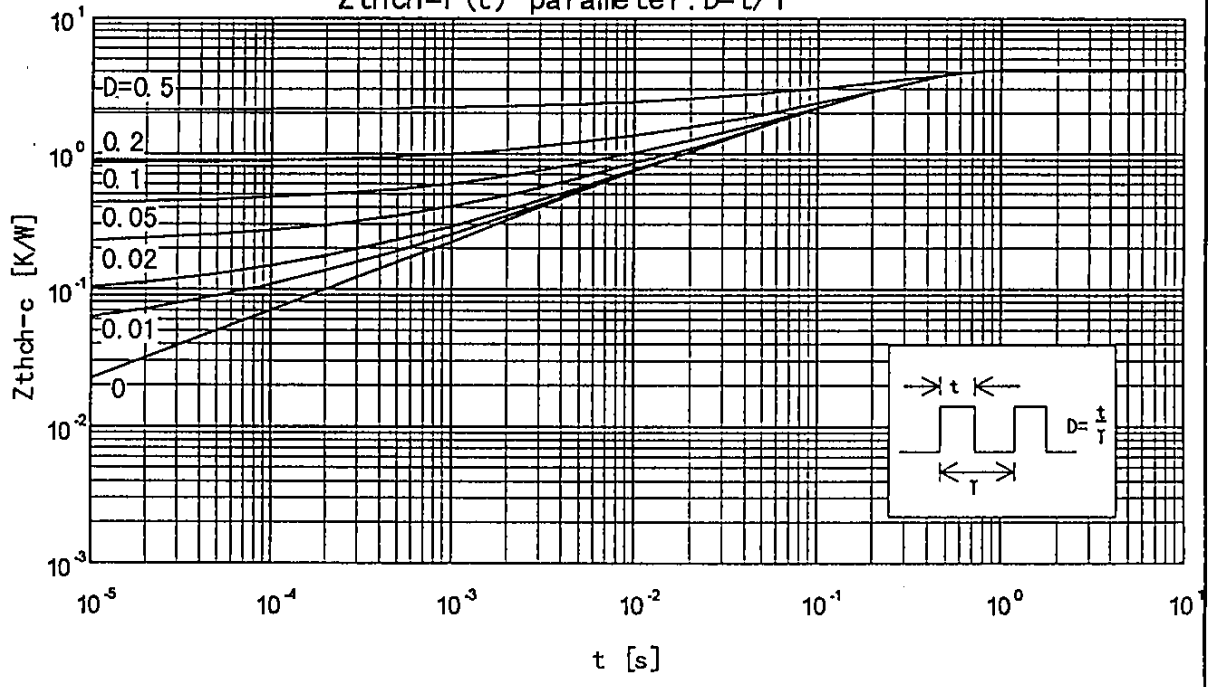


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Forward characteristic of reverse of diode  
 $I_F = f(V_{SD}) : 80 \mu s$  pulses test,  $V_{GS} = 0V$



Transient thermal impedance  
 $Z_{thch} = f(t)$  parameter:  $D = t/T$



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Avalanche energy derating  
 $E_{as}=f(\text{starting } T_{ch}): V_{cc}=45V, I_{AV}=8A$

